

IXTH67N10-VB Datasheet N-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|--------------------------|---------------------------------|--------------------|--|--|--|
| V _{(BR)DSS} (V) | $r_{DS(on)}(\Omega)$ | I _D (A) | | | |
| 100 | 0.018 at V _{GS} = 10 V | 72 ^a | | | |

FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

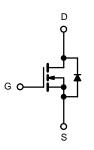


• Isolated DC/DC Converters









N-Channel MOSFET

| Parameter | Symbol | Limit | Unit | | |
|-----------------------------------------------------|-------------------------------------|-----------------------------------|------------------|----|--|
| Drain-Source Voltage | V _{DS} | 100 | | | |
| Gate-Source Voltage | V _{GS} | ± 20 | V | | |
| Continuous Drain Current (T _{.1} = 175 °C) | T _C = 25 °C | I- | 72 ^a | A | |
| Continuous Drain Current (1) = 173 C) | T _C = 125 °C | l _D | 51 ^a | | |
| Pulsed Drain Current | I _{DM} | 240 | А | | |
| Avalanche Current | L = 0.1 mH | | 31 | | |
| Single Pulse Avalanche Energy ^b | L = 0.111111 | E _{AS} | 60 | mJ | |
| Mariana Barra Birata di ah | T _C = 25 °C | В | 355 ^c | W | |
| Maximum Power Dissipation ^b | T _A = 25 °C ^d | $ P_D$ | 3.35 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|-----------|-------------------|-------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Junction-to-Ambient | PCB Mount | R _{thJA} | 40 | °C/W | |
| Junction-to-Case (Drain) | • | R _{thJC} | 0.4 | C/VV | |

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|-----------------------------------------------|----------------------|-------------------------------------------------------------------------|------|-------|-------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$ | 100 | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | | 4 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ | |
| | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 120 | | | Α | |
| | | V _{GS} = 10 V, I _D = 30 A | | 0.018 | | | |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | 0.023 | | Ω | |
| | | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175 ^{\circ}\text{C}$ | | 0.037 | | | |
| Forward Transconductance ^a | 9 _{fs} | $V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$ | 25 | | | S | |
| Dynamic ^b | • | | | | | | |
| Input Capacitance | C _{iss} | | | 3200 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 410 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 210 | | | |
| Total Gate Charge ^c | Q_g | | | 90 | 130 | nC | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 58 \text{ A}$ | | 23 | | | |
| Gate-Drain Charge ^c | Q_{gd} | | | 34 | | | |
| Gate Resistance | R _g | | 0.5 | 1.3 | 3.1 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 24 | 35 | | |
| Rise Time ^c | t _r | $V_{DD} = 100 \text{ V}, R_{L} = 1.5 \Omega$ | | 220 | 330 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 58 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5$ | | 45 | 70 | ns | |
| Fall Time ^c | t _f | Ω | | 200 | 300 | | |
| Source-Drain Diode Ratings and Ch | aracteristics 7 | T _C = 25 °C ^b | | | | | |
| Continuous Current | I _S | | | | 58 | ۸ | |
| Pulsed Current | I _{SM} | | | | 110 | A | |
| Forward Voltage ^a | V_{SD} | I _F = 58 A, V _{GS} = 0 V | | 1.0 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 130 | 200 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 30 A, di/dt = 100 A/μs | | 8 | 12 | Α | |
| Reverse Recovery Charge | Q _{rr} | | | 0.52 | 1.2 | иC | |

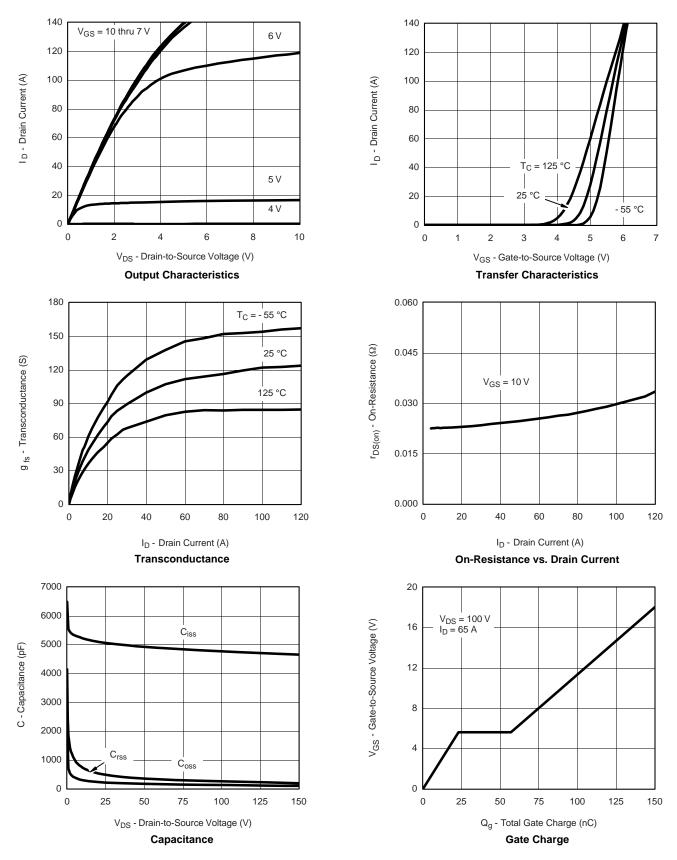
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

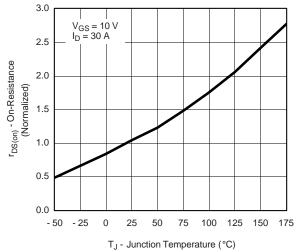


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

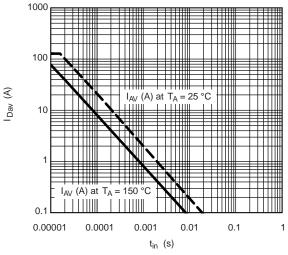




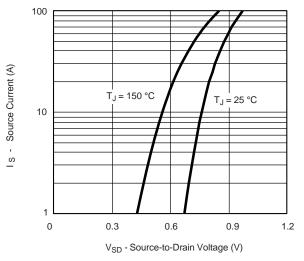
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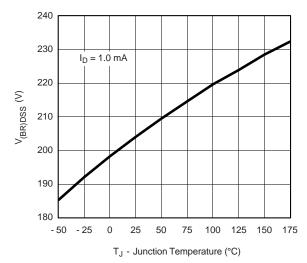
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



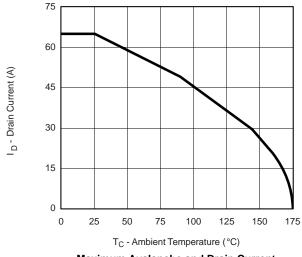
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature

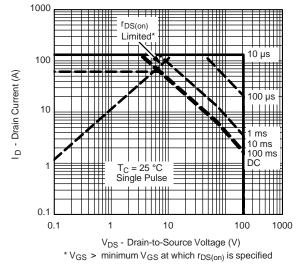


THERMAL RATINGS

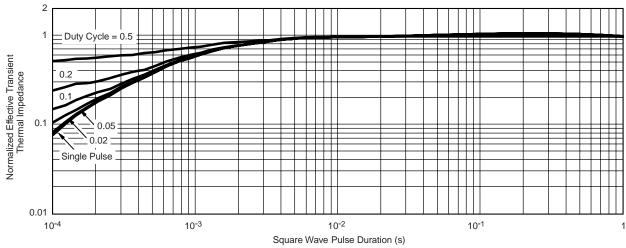


T_C - Ambient Temperature (°C)

Maximum Avalanche and Drain Current
vs. Case Temperature



Safe Operating Area



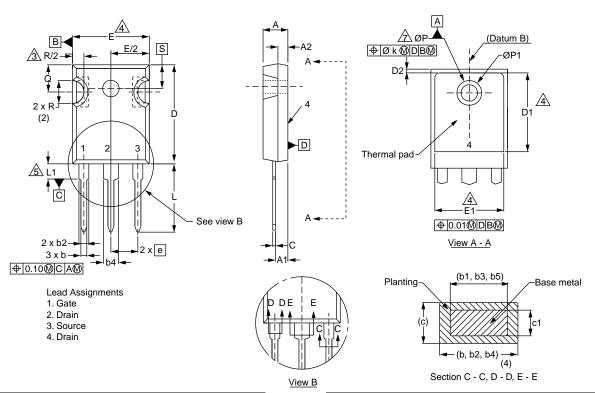
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

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TO-247AC



| | MILLIM | IETERS | INC | HES |
|------|--------|--------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 4.58 | 5.31 | 0.180 | 0.209 |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 |
| A2 | 1.17 | 2.49 | 0.046 | 0.098 |
| b | 0.99 | 1.40 | 0.039 | 0.055 |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 |
| b2 | 1.53 | 2.39 | 0.060 | 0.094 |
| b3 | 1.65 | 2.37 | 0.065 | 0.093 |
| b4 | 2.42 | 3.43 | 0.095 | 0.135 |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 |
| С | 0.38 | 0.86 | 0.015 | 0.034 |
| c1 | 0.38 | 0.76 | 0.015 | 0.030 |
| D | 19.71 | 20.82 | 0.776 | 0.820 |
| D1 | 13.08 | - | 0.515 | - |

| | MILLIM | IETERS | INC | HES |
|------|----------|--------|-----------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| D2 | 0.51 | 1.30 | 0.020 | 0.051 |
| E | 15.29 | 15.87 | 0.602 | 0.625 |
| E1 | 13.72 | - | 0.540 | - |
| е | 5.46 | BSC | 0.215 | BSC |
| Øk | 0.254 | | 0.010 | |
| L | 14.20 | 16.25 | 0.559 | 0.640 |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 |
| N | 7.62 BSC | | 0.300 BSC | |
| ØΡ | 3.51 | 3.66 | 0.138 | 0.144 |
| Ø P1 | - | 7.39 | - | 0.291 |
| Q | 5.31 | 5.69 | 0.209 | 0.224 |
| R | 4.52 | 5.49 | 0.178 | 0.216 |
| S | 5.51 BSC | | 0.217 | BSC |



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